

# Small Signal Diodes MMBD1201 - MMBD1205

#### **Features**

 These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### ABSOLUTE MAXIMUM RATINGS (Note 2, Note 3)

Values are at  $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter		Value	Unit
$V_{RRM}$	Maximum Repetitive Reverse Voltage		100	V
I <sub>F(AV)</sub>	Average Rectified Forward Current		200	mA
	Non-Repetitive Peak Forward Surge Current	Pulse Width = 1.0 s	1.0	Α
		Pulse Width = 1.0 μs	2.0	
T <sub>STG</sub>	Storage Temperature Range		-55 to + 150	°C
$T_J$	Operating Junction Temperature		150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 2. These ratings are based on a maximum junction temperature of 150°C.
- 3. These are steady-state limits. ON Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

### THERMAL CHARACTERISTICS

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Value	Unit
$P_{D}$	Power Dissipation	350	mW
	Derate Above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	357	°C/W



SOT-23 CASE 318-08

### **MARKING DIAGRAM**

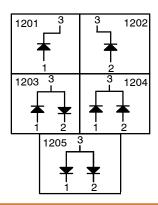


2x = Specific Device Code x = 4, 5, 6, 7, 8 M = Date Code

M = Date Code= Pb-Free Package

(Note: Microdot may be in either location)

### **CONNECTION DIAGRAM**



### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMBD1201, MMBD1203, MMBD1204, MMBD1205	SOT-23 (Pb-Free Halide Free)	3000 / Tape & Reel

#### **DISCONTINUED** (Note 1)

Device	Package	Shipping <sup>†</sup>
MMBD1202	SOT-23 (Pb-Free Halide Free)	3000 / Tape & Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.
- DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

### MMBD1201 - MMBD1205

**ELECTRICAL CHARACTERISTICS** Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
$V_{R}$	Breakdown Voltage	I <sub>R</sub> = 100 μA	100	-	V
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 1.0 mA	550	600	mV
		I <sub>F</sub> = 10 mA	660	740	mV
		I <sub>F</sub> = 100 mA	820	920	mV
		I <sub>F</sub> = 200 mA	0.87	1.0	V
		I <sub>F</sub> = 300 mA	-	1.1	V
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 20 V	-	25	nA
		V <sub>R</sub> = 50 V	-	50	nA
		V <sub>R</sub> = 50 V, T <sub>A</sub> = 150°C	-	100	μΑ
C <sub>T</sub>	Total Capacitance	V <sub>R</sub> = 0 V, f = 1.0 MHz	-	2.0	pF
t <sub>rr</sub>	Reverse Recovery Time	$I_F = I_R = 10 \text{ mA}, I_{RR} = 1.0 \text{ mA},$ $R_L = 100 \Omega$	-	4.0	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### TYPICAL PERFORMANCE CHARACTERISTICS

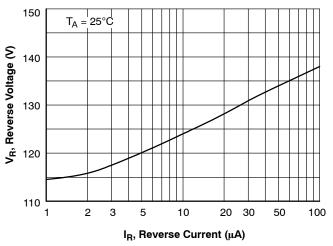


Figure 1. Reverse Voltage vs. Reverse Current  $V_R @\ I_R = 1.0$  to 100  $\mu A$ 

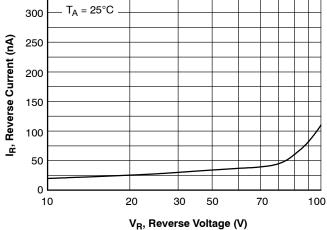
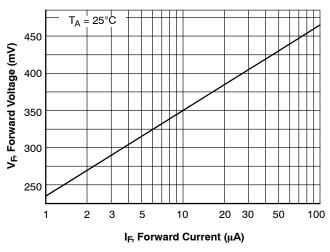


Figure 2. Reverse Current vs. Reverse Voltage  $I_R @V_R = 10 \text{ to } 100 \text{ V}$ 

### MMBD1201 - MMBD1205

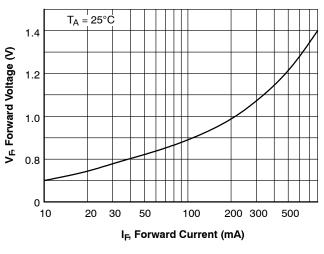
### TYPICAL PERFORMANCE CHARACTERISTICS (continued)



T<sub>A</sub> = 25°C 700 V<sub>F</sub> Forward Voltage (mV) 650 600 550 500 450 0.1 0.2 0.3 0.5 2 3 5 10 I<sub>F</sub>, Forward Current (mA)

Figure 3. Forward Voltage vs. Forward Current  $V_F @ I_F = 1.0$  to  $100~\mu A$ 

Figure 4. Forward Voltage vs. Forward Current  $V_F @ I_F = 0.1$  to 10 mA



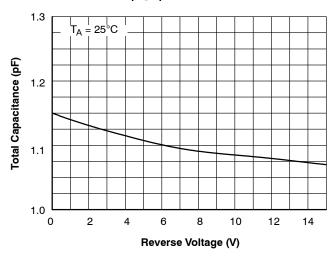
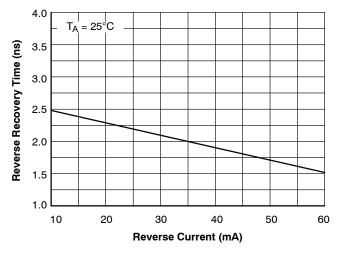


Figure 5. Forward Voltage vs. Forward Current  $V_F @ I_F = 10 \text{ to } 800 \text{ mA}$ 

Figure 6. Total Capacitance vs. Reverse Voltage



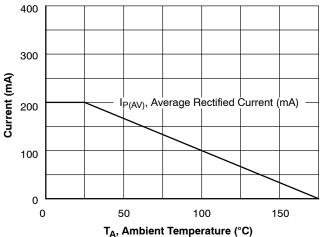


Figure 7. Reverse Recovery Time vs. Reverse Current

Figure 8. Average Rectified Current  $(I_{F(AV)})$  vs. Ambient Temperature  $(T_A)$ 

### MMBD1201 - MMBD1205

## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

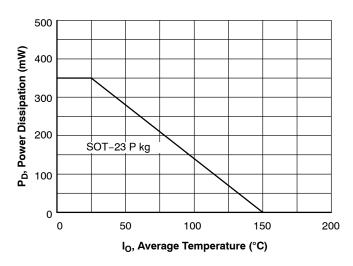


Figure 9. Power Derating Curve

**MILLIMETERS** 

MIN

0.89

0.01

0.37

0.08

2.80

1.20

1.78

0.30

0.35

2.10

O°

NOM

1.00

0.06

0.44

0.14

2.90

1.30

1.90

0.43

0.54

2.40

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### SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**

**DATE 14 AUG 2024** 

MAX

1.11

0.10

0.50

0.20

3.04

1.40

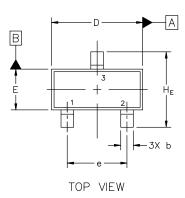
2.04

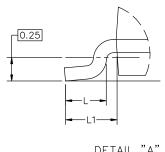
0.55

0.69

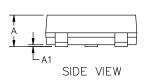
2.64

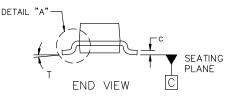
10°

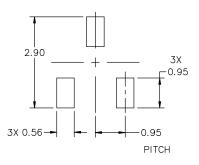




DETAIL "A" Scale 3:1







### NOTES:

DIM

Α

Α1

b

С

D

Ε

е L

L1

HE

Τ

- DIMENSIONING AND TOLERANCING 1. PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS:
- MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- BASE MATERIAL.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

### RECOMMENDED MOUNTING FOOTPRINT

\* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### **STYLES ON PAGE 2**

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<sup>\*</sup>This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

### SOT-23 (TO-236) 2.90x1.30x1.00 1.90P CASE 318 ISSUE AU

DATE 14 AUG 2024

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR			
STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 10: PIN 1. DRAIN 2. SOURCE 3. GATE	2. CATHODE 2.	2: STYLE 13: CATHODE PIN 1. SOURCE CATHODE 2. DRAIN ANODE 3. GATE	STYLE 14: PIN 1. CATHODE 2. GATE 3. ANODE
STYLE 15: PIN 1. GATE 2. CATHODE 3. ANODE	STYLE 16: PIN 1. ANODE 2. CATHODE 3. CATHODE	2. ANODE 2.	3: STYLE 19: NO CONNECTION PIN 1. CATHODE CATHODE 2. ANODE ANODE 3. CATHODE-ANODE	STYLE 20: PIN 1. CATHODE 2. ANODE 3. GATE
STYLE 21: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT			STYLE 26: PIN 1. CATHODE 2. ANODE 3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE			

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